

SHARP SERVICE MANUAL

CODE: 00ZCE126PSM/E

MODEL CE-126P



1. PRODUCTS OUTLINE

The CE-126P printer is an optional printer with the cassette interface designed for use with the pocket computer models PC-1245, PC-1250, PC-1251, and PC-1401 (EL-5500).

2. SPECIFICATIONS

Printer type: Dot matrix thermal printer (MTP-201), identical to the one used for the CE-125

Printing positions: 24 printing positions

Print speed: Approx. 0.8 lines/second

Paper feed speed: Approx. 0.8 lines/second

Recording paper: CPAPR1025CC05 (EA1250P, identical to the one used for the CE-125)
Thermal recording paper (paper roll with outer diameter of 18 mm, maximum, and width of 58mm)

Power supply: Uses four UM3 (AA) dry cell batteries.
Options:
AC adaptor (EA-23E)
NiCd battery (EA-27B) (use of the EA-23E for recharge)

Power consumption: 3 watts

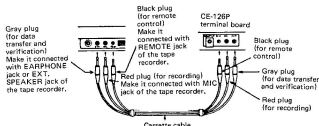
Battery life:
UM3: Approx. 2000 lines
SUM3: Approx. 3000 lines
EA-27B: Approx. 5000 lines
(recharge time: about 15 hours)

Physical dimensions: 140.5(W) x 116(D) x 23(H) mm

3. TAPE RECORDER INTERFACING METHOD



Pocket computer
PC-1250, PC-1251,
PC-1251H, PC-1245,
PC-1401, etc.



- Use of the CE-125 Tape Recorder exclusively designed for the Pocket Computer is recommended.

Cassette Tape Recorder

The following is a description of the minimum tape recorder specifications necessary for interfacing with the CE-126P.

Item	Requirements
1. Recorder Type	Any tape recorder, standard cassette or micro-cassette recorder, may be used in accordance with the requirements outlined below.
2. Input Jack	The recorder should have a mini-jack input labeled "MIC". Never use the "AUX" jack.
3. Input Impedance	The input jack should be a low impedance input (200 ~ 1,000 OHM.)
4. Minimum Input Level	Below 3 mV or -50 dB.
5. Output jack	Should be a minijack labeled "EXT." (EXTernal speaker), "MONITOR", "EAR (EARphone)" or equivalent.
6. Output impedance	Should be below 10 OHM.
7. Output level	Should be above 1V (practical maximum output above 100 mW)
8. Distortion	Should be within 15% within a range of 2 kHz through 4 kHz.
9. Wow and Flutter	0.3% maximum (W.R.M.S.)
10. Other	Recorder motor should not fluctuate speed.

SHARP CORPORATION

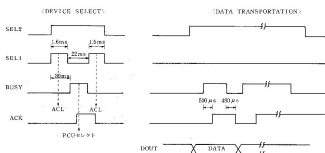
NOTES:

- Some of tape recorders may not operate properly owing to different specification or electrical characteristics affected by signal distortion, electrical noise, level drop-out caused after long years of use.
- When using the tape recorder fitted with the mixing feature, it needs to disable the mixing function for both recording and playback.
- Depending on the tape recorder used, better reading result may be attained when the red plug is unplugged from the MIC jack.
- As it may impede proper data transfer and verification depending on the position of the volume control, tone control, bass control, and treble control, try to find the optimum level by varying their positions.

4. CIRCUIT DESCRIPTION

The CE-126P has two microprocessors; the P-CPU by which data transfer is carried out with the host CPU (M-CPU) and the printer control PCU. Since the host CPU (PC-1245, 1250, 1251, 1401, (EL5500) have different CPU actions, the CE-126P CPU therefore performs different action.

M-CPU to P-CPU data transfer method (for PC-1245, 1250, 1251)



4-1.

What action should the P-CPU take prior to data transfer is dependent on the state of SEL1 and SEL2 from the M-CPU. (DEVICE SELECT)

SEL1	SEL2	Action
L	L	Nop
L	H	PCU select
H	L	Remote ON
H	H	ACL

4-2.

The following actions take place before data transfer.

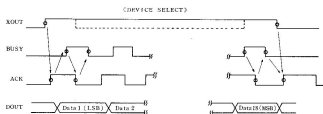
- SEL1 goes low and SEL2 high.
- BUSY from the M-CPU turns high level.
- Upon receipt of BUSY, ACK of the P-CPU is set high and the data is received to the P-CPU.

Since the data is transferred in bit by bit serial mode, above steps (2) and (3) are repeated eight times to complete transfer of one data. For instance, those steps are repeated for 192 times (24 x 8) in order to transfer a 24 digits data. The print command, however, is sent out to the P-CPU at the end of the data in a form of the code "0D"

4-3.

M-CPU to P-CPU data transfer method (for PC-1401, EL5500)

Since there are no SEL1 and SEL2 used for the PC-1401 and EL5500, DEVICE SELECT is dependent on the contents of data.



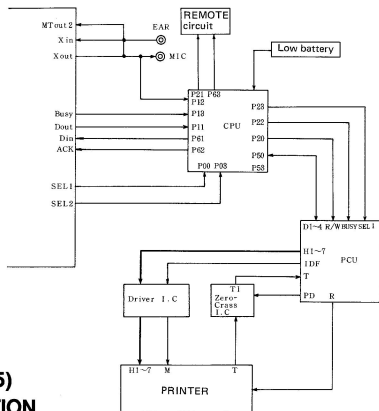
- For DEVICE SELECT, XOUT becomes high.
- As the P-CPU receives a high state of XOUT, it sends ACK to the M-CPU.
- As the M-CPU receives ACK, it sends back BUSY.
- Data is received to the P-CPU with a high state of BUSY. ACL, REMOTE ON, CPU select actions is carried out depending on the contents of data.

4-4. Print data transfer



XOUT goes low when the print data is transferred. Data transfer is done in a manner identical to those of the PC-1250.

5. BLOCK DIAGRAM



6. CPU (UPD7506G515) SIGNAL DESCRIPTION

Pin No.	Signal Name	In/Out	Description
P03	SEL2	In	Select
P00	SEL1	In	Select
P13	BUSY	In	Handshake, active high
P12	XOUT	In	Device select, active high
P11	DOUT	In	Data, active high
P10	DOUT	In	Printer error
P23	ACL/SEL1	Out	High: ACL Low: normal
P22	CS/SEL2	Out	High: chip select Low: non-select
P21	REMO2	Out	Remote off Remote off pulse generation
P20	R/W	Out	High: read, "High to low transition: write"
P43	P/S	In	Data transfer mode High: parallel Low: serial
P42	NORMAL PAPER/ THERMAL PAPER	In	PCU select High: normal paper PCU Low: thermal paper PCU
P41	LOW BATTERY	In	Low battery check High: normal Low: low battery
P40	ACK	In	Handshake (PCU to printer CPU)
P53	D3	In/Out	Data line between CPU and PCU MSB (High 1, Low 0)
P52	D2	In/Out	Data line between CPU and PCU (High 1, Low 0)
P51	D1	In/Out	Data line between CPU and PCU (High 1, Low 0)
P50	D0	In/Out	Data line between CPU and PCU LSB (High 1, Low 0)
P63	REMO1	Out	Remote on Remote on pulse generation
P62	ACK	Out	Handshake (to host CPU), active high
P61	DIN	Out	Printer error (to host CPU)
P60	BUSY	Out	High: printer error Low: normal Handshake (printer CPU to PCU), active high

7. PCU (SC6994) SIGNAL DESCRIPTION

Pin No.	Signal Name	In/Out	Description
1	SEL2	In	Select
2	SEL1	In	Select
3	VDD	Out	Power supply
4	ACL		Not used
5	BUSY	In	High: chip select - - - - - Low: Non-select
6	R/W	In	High: read High to low transition: write
7 ~ 10	D4 ~ 1	In	Data input
11	STP		Not used
12	S	In	Data transfer mode select line High: serial input - - - - - Low: parallel input/output
13	24	In	Print digit select line High: 24 digits (GND connected) Low: 16 digits
14	IDF	Out	Printer motor drive signal
15	H7	Out	Printhead element on pulse
16	H6	Out	Printhead element on pulse
17	GND	In	Power supply
18 ~ 22	H5 ~ H1	Out	Printhead element on pulse
23	R	In	Printer reset (printhead home position detect)
24	PD	Out	Power down (in supply during printer operating cycle, otherwise, power is not supplied to the printer drive circuit).
25	T	In	Printer timing (generated from the tachogenerator of the motor)
26 ~ 28	TS1 ~ 3	In	Test pins
29	VP1	Out	Printer control circuit supply power
30 ~ 32	BC1 ~ 3	In/Out	PCU frequency control
33	CCK	Out	Clock test pin
34	HA	In	<div>Not used</div> <div>→ (Print density adjust pin...JA and JB pin connection varies according to the printhead rank).</div>
35	HB		
36	HC	In	
37, 38	CL1, 2	In	Basic clock pulse control resistor fitting pin
39	PF	In	Paper feed key input
40	NP	In	GND Connected
41	ACL	In	All clear input
42	OP3	Out	ACL select (high when on)
43	OP2		Not used.
44	OP1		Not used.

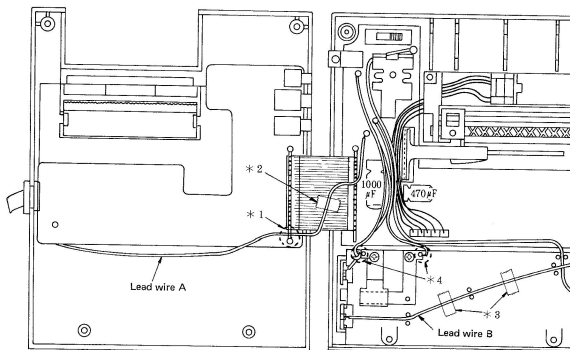
8. SERVICE CAUTIONS

8-1. Cautions in exchanging the printer unit

In order to prevent print density variation caused by thermal head resistance variation, the printhead is classified into three ranks of A, B, and C, and the rank is indicated on the reverse side of the printer unit F.P.C. After exchange of the printer unit, relevant circuit change must be observed in accordance with the procedure mentioned below.

Short JA when the rank A printer is used.
Leave all open when the rank B printer is used.
Short JC when the rank C printer is used.

8-2. Threading lead wires



- Be sure to observe the following cautions in installing lead wire.

*1,*2: The lead wire A must be threaded under the cotton wire and fixed on the F.P.C. using the adhesive tape.

*3: The lead wire B should be fixed with the adhesive tape along the rib of the bottom cabinet.

*4: Do not allow the strayed lead wire to extend out of the Ni-Cd battery terminal printer unit, when the lead wire is connected to the NiCd battery terminal.

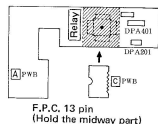
(Unless lead wires A and B are threaded properly to recharge the dry battery (UM3 or of slack lead wires, when the AC adaptor dry batteries in installation.

8-3. [C] Installing PWB

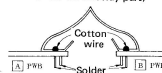
- (1) Set the lead wire to the given location of the [A] PWB and solder it.
- (2) As shown in the figure, apply the double tack adhesive tape over the CPU (UPD7506G) on the [A] PWB, then set the [C] PWB over it with the hole facing the relay.
- (3) After the installation of the [C] PWB, solder the lead wire to the [C] PWB.

8-4. Connecting [A] with [B]

As shown in the figure, fix the 13-pin F.P.C. with the cotton wire. The cotton wire also has to be soldered in a same manner as the F.P.C.



F.P.C. 13 pin
(Hold the midway part)



means of the 20-
m print quality is
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s midway.
t density variation

g paper

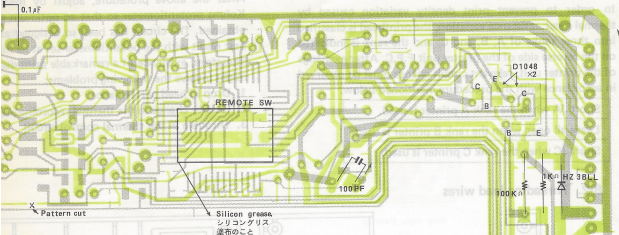


wire and solder to
terminal to the
is being soldered

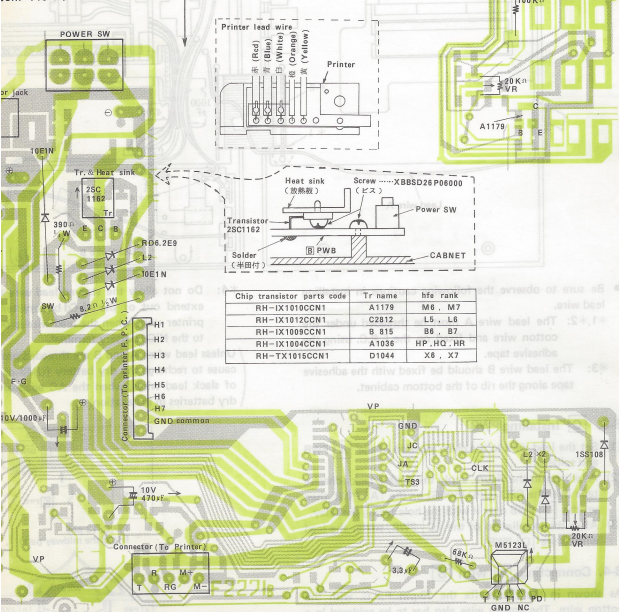
properly, it may
(3 or AA) because
otor is used with



PWB



from view)

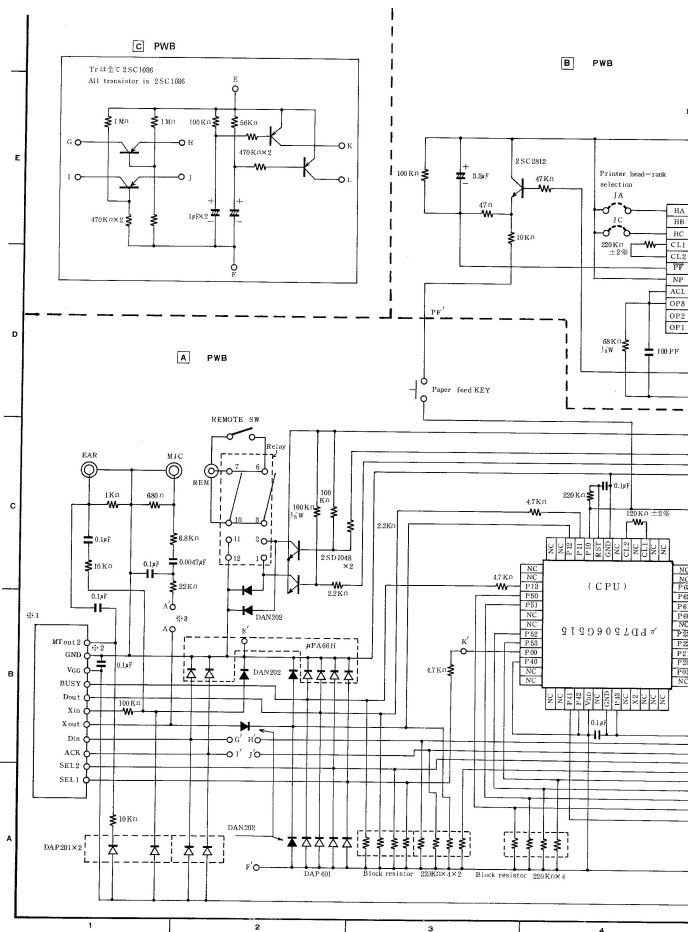


Chip transistor parts code	Tr name	hfe rank
RH-IX1010CCN1	A1179	M6, M7
RH-IX1012CCN1	C2812	L5, L6
RH-IX1009CCN1	B 815	B6, B7
RH-IX1004CCN1	A1036	HP, HQ, HR
RH-TX1015CCN1	D1044	X6, X7

GND NC



10. CIRCUIT DIAGRAM



11. PARTS LIST & GUIDE

1 Exteriors (外装機構部品)

NO.	PARTS CODE	PRICE RANK		NEW MARK	PART RANK	DESCRIPTION
		Ja	Ex			
1	G0VVA1363CCZZ	D	F	A	D	ペーパーカバー Paper cover
2	PCUT-1025CCZZ	D	D	A	C	ペーパーカッター Paper cutter
3	G0ABB2761CCZZ	D	S	A	N	キャビネット Top cabinet
4	JKNB21225CC01	D	A	A	C	スイッチ SW ツマミ Slide switch knob
5	QCN1M1042CCZZ	D	A	A	C	スライド SW コンタクト Slide switch terminal
6	JKNB21877CC01	D	K	A	E	キートップ Key top (Paper feed key)
7	PGUMM1337CCZZ	D	B	A	B	ゴムスプリング Rubber spring
8	QCNW-1268CCZZ	F	G	A	N	11PIN コネクター ケーブル 11pin connector cable
9	TC0UK1217CCZZ	D	A	A	N	チェウイ ラベル Caution label (Japanese & English)
10	PH0G-1093CCZZ	D	C	A	B	11ピン コネクターケーブル用ゴムキャップ Rubber cap for 11pin connector cable
11	XUBSD20P04000	D	A	A	A	C ビス Screw
12	PSLDC1430CCZZ	D	D	A	C	シールドパン Shield
13	QTANZ1454CCZZ	D	B	A	B	デンチタンシ Battery terminal (C)
14	G0ABA2762CCZZ	D	S	A	G	D キャビネット Bottom cabinet
15	GFTAB1189CC01	D	D	A	C	D デンチ フタ Battery lid
16	PCUSS1227CCZZ	D	A	A	N	C デンチオサエヨウ クッション Cushion
17	QTANZ1186CCZZ	D	A	A	B	D デンチタンシ Battery terminal (C)
18	GLEGG1011CCZZ	D	A	A	B	B ゴムアシ Rubber leg
19	XUBSF26P10000	D	A	A	C	C ビス Screw
20	LY-921129CCZZ	D	A	A	C	C ビス Screw
21	QCN1M1062CCZZ	D	B	A	N	C ニックドヨウカドウ Ni-Cd terminal
22	QCN1F1061CCZZ	D	B	A	N	C ニックドヨウカドウ Ni-Cd terminal
23	PSHEP1108CCZZ	D	A	A	N	C SL-SW カクシイタ SL-SW spacer
24	PCUSG1228CCZZ	D	A	A	N	C ラバークッション Rubber cushion
25	PCUSS1218CCZZ	D	A	A	C	C プリンタークッション Printer cushion
26	K1-0B0081CCZZ	H	L	B	G	E サーマルプリンター Thermal printer unit (MTP-201)
27	QCNWC1321CC03	D	J	A	E	B コネクター 5PIN Connector 5pin (with lead wire)

2 PWB unit (基板ユニット)

NO.	PARTS CODE	PRICE RANK		NEW MARK	PART RANK	DESCRIPTION
		Ja	Ex			
1	PRDAR1035CCZZ	D	E	A	N	B ホウネツパン Heat sink
2	PTPEH12214CCZZ	D	A	A	N	C コデイチープ Adhesive tape (for C-PWB)
3	QCNWC1308CCA1	D	E	A	C	B サーマルプリンター-FPCコネクタ Connector for printer (Spin Black)
4	QCNCM1323CC0F	D	B	A	G	B コネクター Connector (Spin Blue)
5	QCNW-1278CCZZ	D	E	A	C	N F.P.C. (13pin) F.P.C. (13pin)
6	QJAKC1003CCZZ	D	H	A	D	B ジャック Jack (for AC adaptor)
7	QJAKC1013CCZZ	D	D	A	C	B ジャック Jack (for MIC, EAR)
8	QJAKC1016CCZZ	D	H	A	C	B ジャック Jack (for Remote)
9	QSW-S0075FCZZ	D	L	A	F	B スライドスイッチ Slide switch
10	VCTYPU1X104M	D	B	A	B	C コンデンサー Capacitor (12WV 0.10μF)
11	RC-E2108BCC1A	D	E	A	C	C コンデンサー Capacitor (10V 1000μF)
12	RC-E2477ACC1A	D	D	A	C	C コンデンサー Capacitor (10V 470μF)
13	RC-S21001CCZZ	D	L	A	F	C コンデンサー Capacitor (1μF)
14	RC-S21021CCZZ	D	E	A	C	C コンデンサー Capacitor (10WV 3.3μF)
15	RH-1X1010CCZZ	D	C	A	B	B トランジスタ Transistor (A1179M6)
16	RH-1X1015CCZZ	D	D	A	C	B トランジスタ Transistor (D1048, x6 x7)
17	RH-1X1016CCZZ	D	D	A	C	B トランジスタ Transistor (C1652-PQR)
18	RMPTC4224QCKB	D	Y	A	K	C ブロックタイコウ Block resistor (1/8W 220KΩ ±10%)
19	RLLYZ2400QCCZ	E	N	A	P	B リレー Relay
20	RVR-M2415QCCZ	D	F	A	D	B ボリウム Variable resistor
21	VCKYPU1H8101K	D	A	A	A	C コンデンサー Capacitor (50WV 100pF)
22	VHDS1588L2-1	D	B	A	B	B ダイオード Diode (DS1588L2)
23	VHDISS108//1	D	B	A	B	B ダイオード Diode
24	VHDI0E1N//1	D	B	A	B	B ダイオード Diode (10E1N)
25	VHEH23BL//1	D	D	A	C	B ヴェナードイオード Zener diode
26	VHERD6.2E9//1	D	B	A	B	B ヴェナードイオード Zener diode
27	VHIDAP201//1	D	A	A	C	B ダイオードアレイ Diode array
28	VHIDAP401//1	D	Q	A	E	B ダイオードアレイ Diode array
29	VHILB1256MFP1	E	A	A	K	B IC IC
30	VHIM5123L//1	D	S	A	G	B IC IC M5123L
31	VH1UPA66H//1	D	L	A	F	B ダイオードアレイ Diode array
32	VRD-ST2BY102J	D	A	A	A	C テイコウ Resistor (1/8W 1.0KΩ ±5%)
33	VRD-ST2BY103J	D	A	A	A	C テイコウ Resistor (1/8W 10KΩ ±5%)
34	VRD-ST2BY104J	D	A	A	A	C テイコウ Resistor (1/8W 100KΩ ±5%)
35	VRD-ST2BY683J	D	A	A	A	C テイコウ Resistor (1/8W 68KΩ ±5%)
36	VRD-ST2EY391J	D	B	A	A	C カーボンテイコウ Resistor (1/4W 390Ω ±5%)
37	VRD-ST2HY8R2J	D	A	A	A	C テイコウ Resistor (1/2W 8.2Ω ±5%)
38	VS25C1162-CDC	D	L	A	E	B トランジスタ Transistor
39	XBBSD26P06000	D	A	A	A	C ビス Screw
40	RC-CZ1031CCN1	D	B	A	B	C コンデンサー Capacitor (0.1μF)
41	RC-CZ1031CCN1	D	B	A	B	C コンデンサー Capacitor (1000pF)
42	RC-CZ1035CCN1	D	B	A	B	C コンデンサー Capacitor (100pF)
43	RC-CZ1039CCN1	D	B	A	B	C コンデンサー Capacitor (4700pF)

2 PWB unit (基板ユニット)

NO.	PARTS CODE	PRICE RANK		NEW MARK	PART RANK	DESCRIPTION
		Ja	Ex			
44	RC-CZ1052CCN1	DB	AB		C	コンデンサー Capacitor (150pF)
45	RH-DZ1008CCN1	DD	AC		B	ダイオードアレイ Diode array (DAN202)
46	RH-IX1004CCN1	DH	AD		B	トランジスター Transistor (A1036)
47	RH-IX1009CCN1	DD	AC		B	トランジスター Transistor (B815,B6,B7)
48	RH-IX1010CCN1	DD	AC		B	トランジスター Transistor (A1179,M6)
49	RH-IX1012CCN1	DD	AC		B	トランジスター Transistor (C2812,L5,L6)
50	RR-KZ1051CCN1	DA	AA		C	タイコウ Resistor (220KΩ ±2%)
51	RR-KZ1053CCN1	DA	AA		C	タイコウ Resistor (120KΩ ±2%)
52	RR-KZ1056CCN1	DA	AA		C	タイコウ Resistor (20KΩ ±2%)
53	RR-KZ1057CCN1	DA	AA		C	タイコウ Resistor (15KΩ ±2%)
54	VH-ID7506G-515	FJ	AU		B	IC IC
55	VH-ISC6994//1	FC	AS		B	IC IC
56	VRS-TP2BD102J	DA	AA		C	タイコウ Resistor (1/8W 1.0KΩ ±5%)
57	VRS-TP2BD103J	DA	AA		C	タイコウ Resistor (1/8W 10KΩ ±5%)
58	VRS-TP2BD104J	DA	AA		C	タイコウ Resistor (1/8W 100KΩ ±5%)
59	VRS-TP2BD105J	DA	AA		C	タイコウ Resistor (1/8W 1.0MΩ ±5%)
60	VRS-TP2BD220J	DA	AA		C	タイコウ Resistor (1/8W 22Ω ±5%)
61	VRS-TP2BD222J	DA	AA		C	タイコウ Resistor (1/8W 2.2KΩ ±5%)
62	VRS-TP2BD223J	DA	AA		C	タイコウ Resistor (1/8W 22KΩ ±5%)
63	VRS-TP2BD224J	DA	AA		C	タイコウ Resistor (1/8W 220KΩ ±5%)
64	VRS-TP2BD332J	DA	AA		C	タイコウ Resistor (1/8W 3.3KΩ ±5%)
65	VRS-TP2BD470J	DA	AA		C	タイコウ Resistor (1/8W 47Ω ±5%)
66	VRS-TP2BD471J	DA	AA		C	タイコウ Resistor (1/8W 470Ω ±5%)
67	VRS-TP2BD472J	DA	AA		C	タイコウ Resistor (1/8W 470KΩ ±5%)
68	VRS-TP2BD473J	DA	AA		C	タイコウ Resistor (1/8W 4.7KΩ ±5%)
69	VRS-TP2BD474J	DA	AA		C	タイコウ Resistor (1/8W 47KΩ ±5%)
70	VRS-TP2BD563J	DA	AA		C	タイコウ Resistor (1/8W 56KΩ ±5%)
71	VRS-TP2BD681J	DA	AA		C	タイコウ Resistor (1/8W 680Ω ±5%)
72	VRS-TP2BD682J	DA	AA		C	タイコウ Resistor (1/8W 6.8KΩ ±5%)
ユニット (Unit)						
900	DUNTK7627CCZZ	MV	BR	N	E	PWB ユニット PWB unit

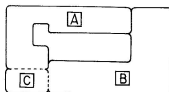
3 Accessory (付属品)

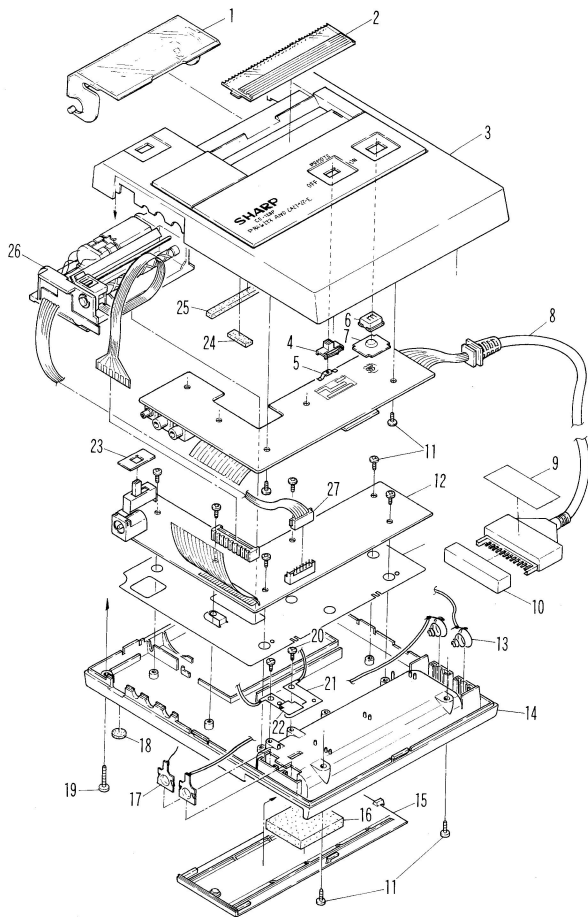
NO.	PARTS CODE	PRICE RANK		NEW MARK	PART RANK	DESCRIPTION
		Ja	Ex			
1	SPAKA8215CCZZ	DM	AF	N	D	SET ヨウ クッション Packing cushion for set
2	SPAKA8216CCZZ	DE	AC	N	D	フツク ヨウ クッション Packing cushion for Accessories
3	SPAKC8217CCZZ	DR	AG	N	D	パッキングケース Packing case (Japan)
3	SPAKC8219CCZZ	DR	AF	N	D	パッキングケース Packing case (Other country)
4	TINSJ4640CCZZ	DP	AF	N	D	トリアツカイセツメイショ Instruction book (Japan)
4	TINSE4641CCZZ	DY	AK	N	D	トリアツカイセツメイショ Instruction book (U.S.A.)
4	TINSM4043CCZZ	EJ	AN	N	D	トリアツカイセツメイショ Instruction book (E.F.G.S.I)
5	UBAGC1382CCZZ	DU	AG	N	D	ソフトケース Soft case
6	QPLGJ1014CCZZ	FB	AR		D	カセットプラグ A Cassette cable
7	CPAPRI025CC05	ZZ			S	ロールペーパー (5コ/1パック) (Japan only)
8	TLABH1955CCZZ	DB	AB			セツメイ ラベル Operation label (Except Japan)

* PWB unit

The PWB unit (DUNTK7627CCZZ) consists of **A**, **B**, and **C**, altogether.

PWB unit





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SHARP

SHARP CORPORATION
Industrial Instruments Group
Reliability & Quality Control Department
Yamatokoriyama, Nara 639-11, Japan

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